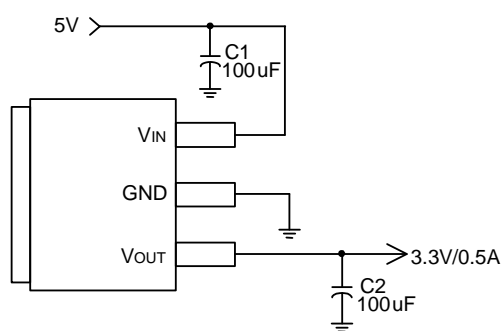
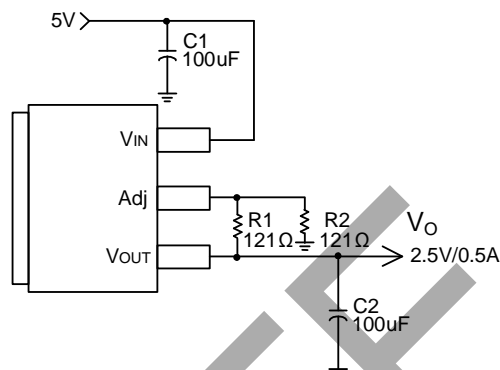


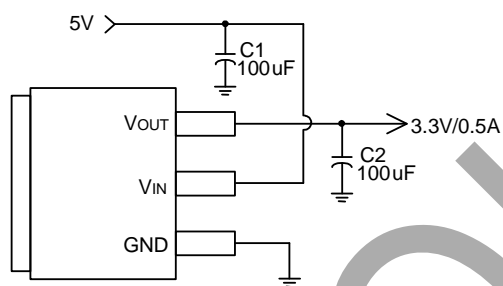
## Typical Applications Circuit



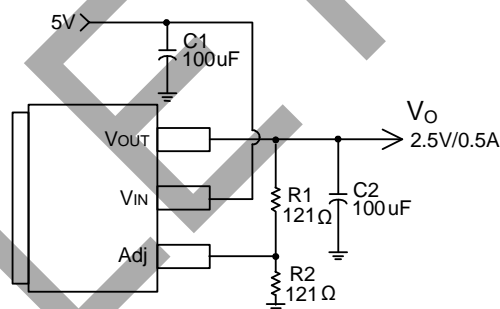
AP1115 A (5V/3.3V Fixed Output)



AP1115 A (5V/2.5V Adj Output)



AP1115 B (5V/3.3V Fixed Output)



AP1115 B (5V/2.5V Adj Output)

Note:  $V_o = V_{REF} \times (1 + \frac{R_2}{R_1})$

## Pin Descriptions

Pin Name	I/O	Function
Adj (GND)	I	A resistor divider from this pin to the V <sub>OUT</sub> pin and ground sets the output voltage (Ground only for Fixed-Mode).
V <sub>OUT</sub>	O	The output of the regulator. A minimum of 10uF capacitor (0.15Ω ≤ ESR ≤ 20Ω) must be connected from this pin to ground to insure stability.
V <sub>IN</sub>	I	The input pin of regulator. Typically a large storage capacitor (0.15Ω ≤ ESR ≤ 20Ω) is connected from this pin to ground to insure that the input voltage does not sag below the minimum dropout voltage during the load transient response. This pin must always be 1.3V higher than V <sub>OUT</sub> in order for the device to regulate properly.

**Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Rating	Unit
V <sub>IN</sub>	DC Supply Voltage	-0.3 to +18	V
P <sub>D</sub>	Power Dissipation	Internally Limited	mW
T <sub>ST</sub>	Storage Temperature	-65 to +150	°C
T <sub>MJ</sub>	Maximum Junction Temperature	+150	°C

Stresses greater than the 'Absolute Maximum Ratings' specified above, may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions exceeding those indicated in this specification is not implied. Device reliability may be affected by exposure to absolute maximum rating conditions for extended periods of time.

**Recommended Operating Conditions**

Symbol	Parameter	Min	Max	Unit
T <sub>OP</sub>	Operating Junction Temperature Range	0	+125	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Conditions	Min	Typ	Max	Unit
Reference Voltage	AP1115-ADJ, T <sub>A</sub> = +25°C, (V <sub>IN</sub> - V <sub>OUT</sub> ) = 1.5V, I <sub>O</sub> = 10mA	1.225	1.250	1.275	V
Output Voltage	AP1115-1.5, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 3V ≤ V <sub>IN</sub> ≤ 12V	1.470	1.500	1.530	V
	AP1115-1.8, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 3.3V ≤ V <sub>IN</sub> ≤ 12V	1.764	1.800	1.836	V
	AP1115-2.5, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 4V ≤ V <sub>IN</sub> ≤ 12V	2.450	2.500	2.550	V
	AP1115-2.8, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 4.3V ≤ V <sub>IN</sub> ≤ 12V	2.744	2.800	2.856	V
	AP1115-3.0, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 4.5V ≤ V <sub>IN</sub> ≤ 12V	2.940	3.000	3.060	V
	AP1115-3.3, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 4.8V ≤ V <sub>IN</sub> ≤ 12V	3.235	3.300	3.365	V
	AP1115-3.5, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 5V ≤ V <sub>IN</sub> ≤ 12V	3.430	3.500	3.570	V
	AP1115-5.0, I <sub>OUT</sub> = 10mA, T <sub>A</sub> = +25°C, 6.5V ≤ V <sub>IN</sub> ≤ 12V	4.900	5.000	5.100	V
Line Regulation	AP1115-XXX, I <sub>O</sub> = 10mA, V <sub>OUT</sub> + 1.5V < V <sub>IN</sub> < 15V, T <sub>A</sub> = +25°C	—	—	0.2	%
Load Regulation	AP1115-ADJ, V <sub>IN</sub> = 3.3V, V <sub>ADJ</sub> = 0.0mA < I <sub>O</sub> < 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	—	1	%
	AP1115-1.5, V <sub>IN</sub> = 3V, 0mA < I <sub>O</sub> < 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	12	15	mV
	AP1115-1.8, V <sub>IN</sub> = 3.3V, 0mA < I <sub>O</sub> < 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	15	18	mV
	AP1115-2.5, V <sub>IN</sub> = 4V, 0mA < I <sub>O</sub> < 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	20	25	mV
	AP1115-2.8, V <sub>IN</sub> = 4.3V, 0mA < I <sub>O</sub> < 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	22	28	mV
	AP1115-3.0, V <sub>IN</sub> = 5V, 0 ≤ I <sub>OUT</sub> ≤ 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	23	30	mV
	AP1115-3.3, V <sub>IN</sub> = 5V, 0 ≤ I <sub>OUT</sub> ≤ 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	26	33	mV
	AP1115-3.5, V <sub>IN</sub> = 5V, 0 ≤ I <sub>OUT</sub> ≤ 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	28	35	mV
	AP1115-5.0, V <sub>IN</sub> = 8V, 0 ≤ I <sub>OUT</sub> ≤ 0.6A, T <sub>A</sub> = +25°C (Notes 4 & 5)	—	40	50	mV

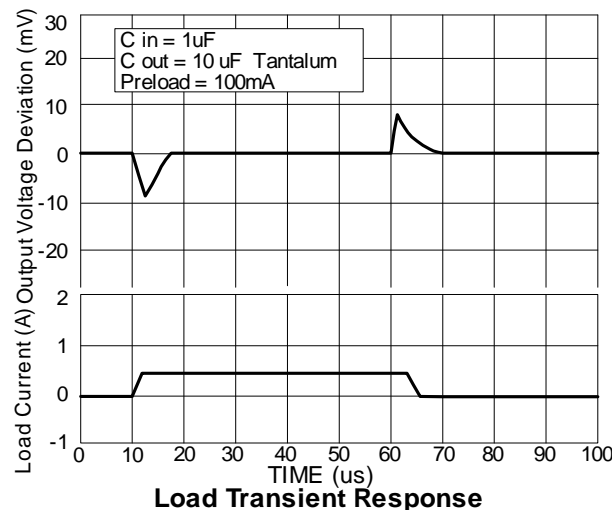
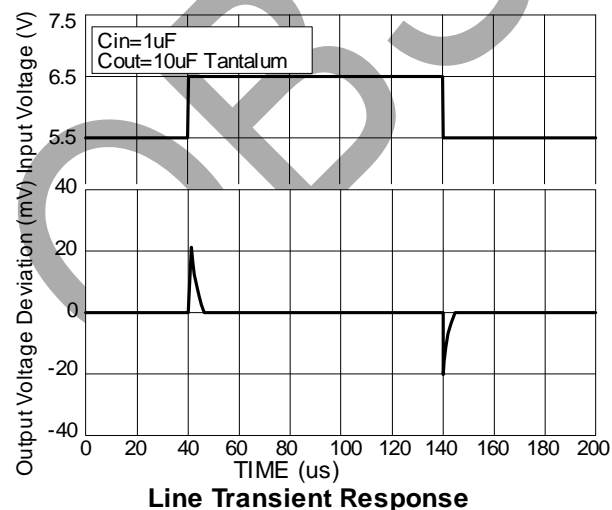
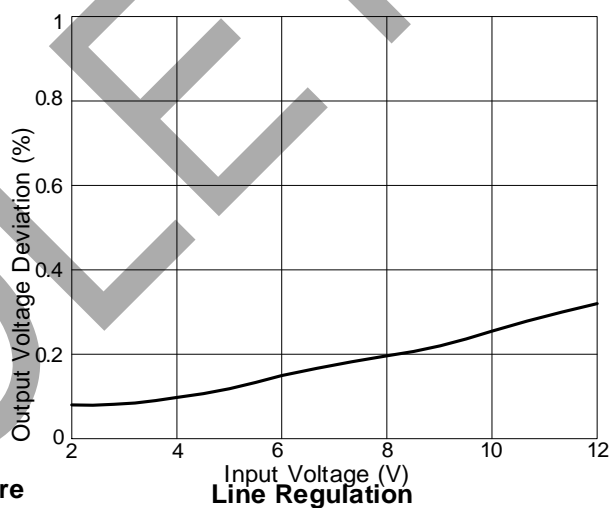
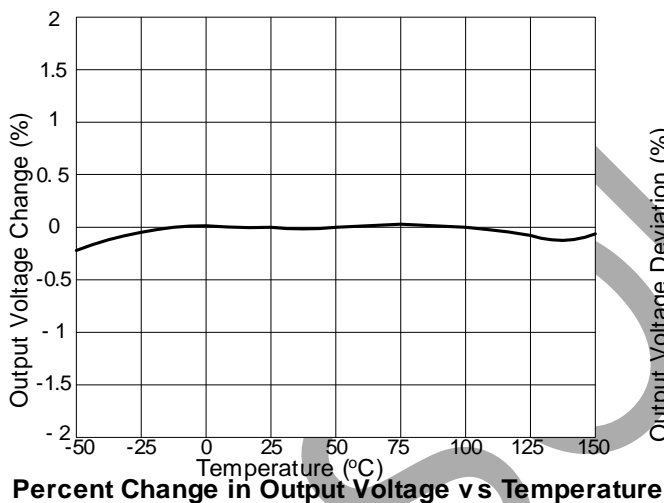
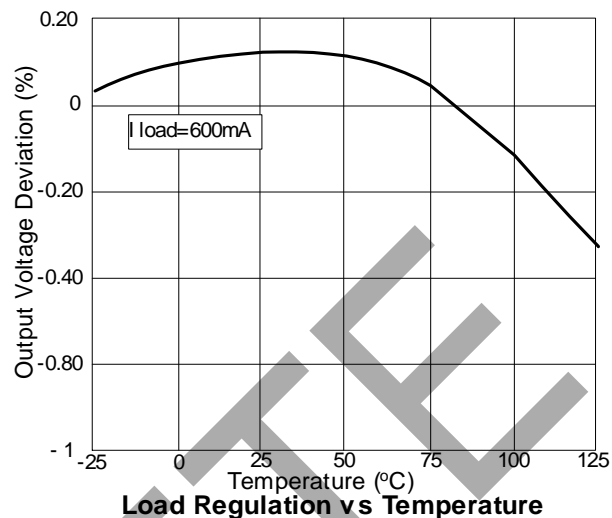
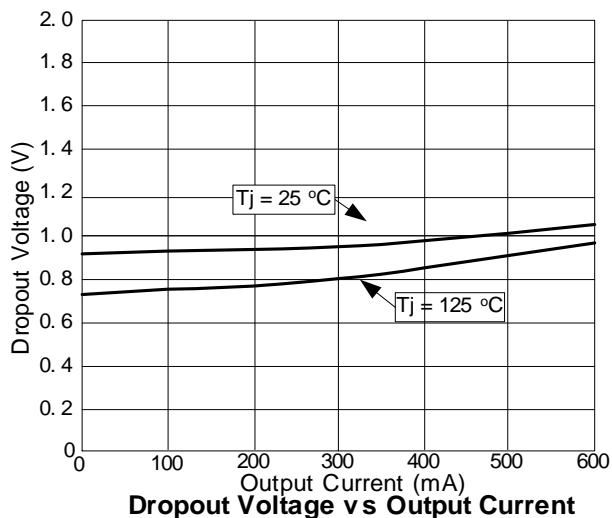
- Notes:
- See thermal regulation specifications for changes in output voltage due to heating effects. Line and load regulation are measured at a constant junction temperature by low duty cycle pulse testing. Load regulation is measured at the output lead = 1/18" from the package.
  - Line and load regulation are guaranteed up to the maximum power dissipation of 5W. Power dissipation is determined by the input/output differential and the output current. Guaranteed maximum power dissipation will not be available over the full input/output range.

**Electrical Characteristics** (cont.) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Conditions		Min	Typ	Max	Unit
Dropout Voltage (V <sub>IN</sub> -V <sub>OUT</sub> )	AP1115-ADJ/1.5/1.8 2.5/2.8/3.0/3.3/3.5/5.0	I <sub>OUT</sub> = 0.6A, ΔV <sub>OUT</sub> = 1%V <sub>OUT</sub>	—	1.1	1.3	V
Current Limit	AP1115-ADJ/1.5/1.8 2.5/2.8/3.0/3.3/3.5/5.0	(V <sub>IN</sub> - V <sub>OUT</sub> ) = 5V	0.7	—	—	A
Minimum Load Current (Note 6)	AP1115-XXX	0°C ≤ T <sub>J</sub> ≤ +125°C	—	5	10	mA
Thermal Regulation	T <sub>A</sub> = +25°C, 30ms pulse		—	0.008	0.04	%/W
Ripple Rejection	f = 120Hz, C <sub>OUT</sub> = 25μF Tantalum, I <sub>OUT</sub> = 0.6A		—	—	—	—
	AP1115-XXX	V <sub>IN</sub> = V <sub>OUT</sub> + 3V	—	60	70	dB
Temperature Stability	I <sub>O</sub> = 10mA		—	0.6	—	%
θ <sub>JA</sub>	Thermal Resistance Junction-to-Ambient (No heat sink; No air flow) (Note 7)		—	164	—	°C/W
θ <sub>JC</sub>	Thermal Resistance Junction-to-Case Control Circuitry/Power Transistor (Note 7)		—	35	—	°C/W

Notes: 6. Quiescent current is defined as the minimum output current required to maintain regulation. At 12V input/output differential the device is guaranteed to regulate if the output current is greater than 10mA.  
7. Test conditions for SOT89-3L: Device mounted on FR-4 substrate, 2oz copper, with minimum recommended pad layout.

## Typical Performance Characteristics



## Ordering Information

AP1115 X Y XX X - 13X

Pin Version	Package	Vout	Lead Free	Packing
A : Pin1 : VOUT 2 : Adj(GND) 3 : VIN	Y : SOT89-3	Blank : ADJ 15 : 1.5V 18 : 1.8V 25 : 2.5V 28 : 2.8V 30 : 3.0V 33 : 3.3V 35 : 3.5V 50 : 5.0V	L : Lead Free G : Green	13 : Tape & Reel 13R : Tape & Reel
B : Pin1 : Adj(GND) 2 : VIN 3 : VOUT				

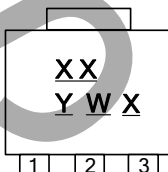
Device	Package Code	Packaging (Note 8)	13" Tape and Reel (Note 9)	
			Quantity	Part Number Suffix
AP1115XYXXL-13	Y	SOT89-3	2500/Tape & Reel	-13
AP1115XYXXG-13	Y	SOT89-3	2500/Tape & Reel	-13
AP1115XYXXL-13R	Y	SOT89-3	4000/Tape & Reel	-13R
AP1115XYXXG-13R	Y	SOT89-3	4000/Tape & Reel	-13R

Notes: 8. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at <http://www.diodes.com/datasheets/ap02001.pdf>.  
9. Find Surface Mount (SMD) Packaging and Reel and Carrier Tape specification in document AP02007.pdf <http://www.diodes.com/datasheets/ap02007.pdf>

## Marking Information

SOT89-3

( Top View )

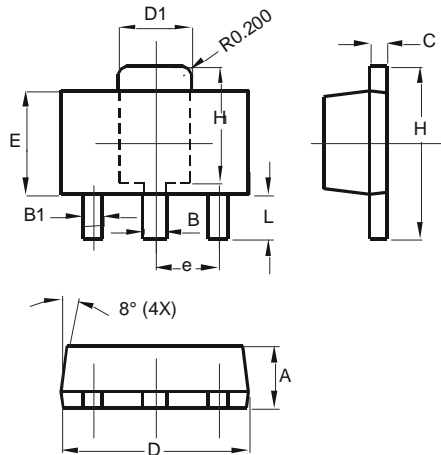


XX : Identification code  
Y : Year : 0~9  
W : Week : A~Z : 1~26 week;  
a~z : 27~52 week;  
z represents 52 and 53 week  
X : Internal code  
a~z : Lead Free  
A~Z : Green

Output Version	Identification Code	
	AP1115A	AP1115B
ADJ	JO	JU
1.5V	JP	JV
1.8V	JQ	JW
2.5V	JR	JX
2.8V	JC	JD
3.0V	JM	JN
3.3V	JS	JY
3.5V	JK	JL
5.0V	JT	JZ

## Package Outline Dimensions (All dimensions in mm.)

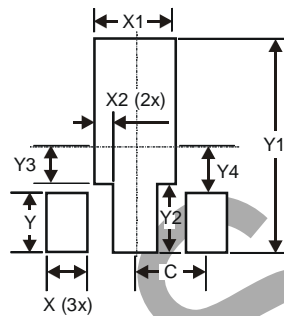
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SOT89-3		
Dim	Min	Max
A	1.40	1.60
B	0.44	0.62
B1	0.35	0.54
C	0.35	0.44
D	4.40	4.60
D1	1.62	1.83
E	2.29	2.60
e	1.50 Typ	
H	3.94	4.25
H1	2.63	2.93
L	0.89	1.20
All Dimensions in mm		

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
C	1.500

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